

UC20 Hardware Design

UMTS/HSPA Module Series

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About the document

History

Revision	Date	Author	Description
1.0	2013-07-17	Mountain ZHOU	Initial
1.1	2013-08-29	Mountain ZHOU	 Updated USB driver information. Added GNSS contents in Chapter 4. Added GNSS current consumption. Updated GNSS antenna requirements. Released USIM_PRESENCE function.



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1 Introduction

This document defines the UC20 module and describes its hardware interface which are connected with your application and the air interface.

This document can help you quickly understand module interface specifications, electrical and mechanical details. Associated with application notes and user guide, you can use UC20 module to design and set up mobile applications easily.



1.1. Safety Information

The following safety precautions must be observed during all phases of the operation, such as usage, service or repair of any cellular terminal or mobile incorporating UC20 module. Manufacturers of the cellular terminal should send the following safety information to users and operating personnel and to incorporate these guidelines into all manuals supplied with the product. If not so, Quectel does not take on any liability for customer failure to comply with these precautions.



Full attention must be given to driving at all times in order to reduce the risk of an accident. Using a mobile while driving (even with a handsfree kit) cause distraction and can lead to an accident. You must comply with laws and regulations restricting the use of wireless devices while driving.



Switch off the cellular terminal or mobile before boarding an aircraft. Make sure it switched off. The operation of wireless appliances in an aircraft is forbidden to prevent interference with communication systems. Consult the airline staff about the use of wireless devices on boarding the aircraft, if your device offers a Airplane Mode which must be enabled prior to boarding an aircraft.



Switch off your wireless device when in hospitals or clinics or other health care facilities. These requests are desinged to prevent possible interference with sentitive medical equipment.



GSM cellular terminals or mobiles operate over radio frequency signal and cellular network and cannot be guaranteed to connect in all conditions, for example no mobile fee or an invalid SIM card. While you are in this condition and need emergent help, please remember using emergency call. In order to make or receive call, the cellular terminal or mobile must be switched on and in a service area with adequate cellular signal strength.



Your cellular terminal or mobile contains a transmitter and receiver. When it is ON, it receives and transmits radio frequency energy. RF interference can occur if it is used close to TV set, radio, computer or other electric equipment.



In locations with potencially explosive atmospheres, obey all posted signs to turn off wireless devices such as your phone or other cellular terminals. Areas with potencially exposive atmospheres including fuelling areas, below decks on boats, fuel or chemical transfer or storage facilities, areas where the air contains chemicals or particles such as grain, dust or metal powders.



2 Product Concept

2.1. General Description

UC20 is an embedded HSPA+/EDGE engine with Rx-diversity. Its UMTS-based modem provides data connectivity on HSPA+, HSDPA, HSUPA, WCDMA, EDGE, GPRS networks. It can also provide GPS/GLONASS and voice functionality for customers' specific application. UC20 offers a maximum data rate of 14.4Mbps on downlink and 5.76Mbps on uplink in HSPA+/HSPA mode. UC20 also supports GPRS/EDGE multi-slot class 12. GPRS supports the coding schemes CS-1, CS-2, CS-3 and CS-4. EDGE supports CS1-4 and MCS1-9 coding schemes. UC20 contains two variants UC20-A and UC20-E. Customer can choose the dedicated type based on the wireless network configuration. The following table shows the entire radio band configuration of UC20 series.

Table 1: UC20 Series Frequency Bands

Module	GSM 850	EGSM 900		PCS 1900	UMTS 850	UMTS 900	UMTS 1900	UMTS 2100	Rx- diversity	GNSS
UC20-A	✓	V	1	√	✓		✓		✓	✓
UC20-E	✓	√	✓	✓		✓		✓	✓	✓

More details about GPRS/EDGE multi-slot configuration and coding schemes, please refer to Appendix B, C and D.

With a tiny profile of 32.0mm × 29.0mm × 2.5mm, UC20 can meet almost all requirements for M2M application such as automotive, metering, tracking system, security solutions, routers, wireless POS, mobile computing devices, PDA phone and tablet PC, etc..

UC20 is an SMD type module, which can be embedded in customer application through its 112-pin pads including 72 LCC signal pads and 40 other pads.

UC20 is integrated with internet service protocols like TCP/UDP and PPP. Extended AT commands have been developed for customer to use these internet service protocols easily.



2.2. Key Features

The following table describes the detailed features of UC20 module.

Table 2: UC20 Key Features

Feature	Details
Power Supply	Supply voltage: 3.4V~4.3V.
Fower Suppry	Typical supply voltage: 3.8V.
Frequency Bands	GSM Quad-band: GSM850, EGSM900, DCS1800, PCS1900. UMTS Dual-band: UC20-E 900/2100 MHz, UC20-A 850/1900 MHz. GPS: 1575.42 MHz. GLONASS: 1597.5~1605.8 MHz.
Transmission Data	HSPA R6: Max 14.4 Mbps (DL)/Max 5.76 Mbps (UL). UMTS R99: Max 384 kbps (DL)/Max 384 kbps (UL). EDGE: Max 236.8 kbps (DL)/Max 236.8 kbps (UL).
Transmission Bata	GPRS: Max 85.6 kbps (DL)/Max 85.6 kbps (UL). CSD: 14.4 kbps.
Transmitting Power	Class 4 (33dBm±2dB) for GSM850 and EGSM900. Class 1 (30dBm±2dB) for DCS1800 and PCS1900. Class E2 (27dBm±3dB) for GSM850 and EGSM900 8-PSK. Class E2 (26dBm+3/-4dB) for DSC1800 and PCS1900 8-PSK. Class 3 (24dBm+1/-3dB) for UMTS 850/900/1900/2100.
HSPA and UMTS Features	HSPA data rate is corresponded with 3GPP R6. 14.4 Mbps on downlink and 5.76 Mbps on uplink. WCDMA data rate is corresponded with 3GPP R99/R4. 384 kbps on downlink and 384 kbps on uplink. Support both QPSK and 16-QAM modulations.
GSM/GPRS/EDGE Data Features	GPRS: Support GPRS multi-slot class 12 (10 by default). Coding scheme: CS-1, CS-2, CS-3 and CS-4. Maximum of four Rx time slots per frame. EDGE: Support EDGE multi-slot class 12 (12 by default). Support GMSK and 8-PSK for different MCS (Modulation and Coding scheme). Downlink coding schemes: CS 1-4 and MCS 1-9. Uplink coding schemes: CS 1-4 and MCS 1-9. CSD: CSD transmission rates: 14.4 kbps non-transparent. Support Unstructured Supplementary Services Data (USSD).



Internet Protocol Features	Support TCP/PPP/UDP protocols. Support the protocols PAP (Password Authentication Protocol) and CHAP (Challenge Handshake Authentication Protocol) usually used for PPP connections.
SMS	Text and PDU mode. Point to point MO and MT. SMS cell broadcast. SMS storage: ME by default.
USIM Interface	Support USIM card: 1.8V, 3V. Support USIM and SIM.
Audio Features	Support one digital audio interface: PCM interface. GSM: HR/FR/EFR/AMR. WCDMA: AMR. Echo cancellation and noise suppression.
PCM Interface	Used for audio function with external codec. Support 8-bit A-law, µ-law and 16-bit linear data formats. Support long frame sync and short frame sync. Support master and slave mode, but must be the master in long frame sync.
UART Interface	 Support two UART interfaces: main UART interface and debug UART interface. Main UART interface: Seven lines on main UART interface. Support RTS and CTS hardware flow control. Baud rate can reach up to 921600 bps, 115200 bps by default. Used for AT command, data transmission or firmware upgrade*. Multiplexing function. Debug UART interface: Two lines on debug UART interface: DBG_TXD and DBG_RXD. Can be used for software debug or GNSS NMEA sentences output.
USB Interface	Compliant with USB 2.0 specification (slave only), the data transfer rate can reach up to 480 Mbps. Used for AT command communication, data transmission, GNSS NMEA output, software debug and firmware upgrade. USB Driver: Support Windows XP, Windows Vista, Windows 7, Windows 8, Windows CE5.0/6.0, Linux 2.6/3.0, Android 2.3/4.0.
Rx-diversity*	Support UMTS Rx-diversity.
GNSS Features	Gen8 of Qualcomm GNSS engine (GPS and GLONASS). Protocol: NMEA 0183.
AT Commands	Compliant with 3GPP TS 27.007, 27.005 and Quectel enhanced AT commands.



Real Time ClockImplemented.Network IndicationTwo pins including NET_MODE and NET_STATUS to indicate network connectivity status.Antenna InterfaceInclude main GSM/UMTS antenna, UMTS diversity antenna, GNSS antenna (active/passive).Physical CharacteristicsSize: 32.0±0.15 × 29.0±0.15 × 2.5±0.2 mm. Weight: approx. 4.9 g.Temperature RangeNormal operation: -35°C ~ +75°C. Restricted operation: -40°C ~ -35°C and +75°C ~ +85°C 1). Storage temperature: -45°C ~ +90°C.Firmware UpgradeUSB interface or main UART interface (UART is not supported currently).RoHSAll hardware components are fully compliant with EU RoHS directive.		
Network Indication network connectivity status. Include main GSM/UMTS antenna, UMTS diversity antenna, GNSS antenna (active/passive). Physical Characteristics Size: 32.0±0.15 × 29.0±0.15 × 2.5±0.2 mm. Weight: approx. 4.9 g. Normal operation: -35°C ~ +75°C. Restricted operation: -40°C ~ -35°C and +75°C ~ +85°C 1). Storage temperature: -45°C ~ +90°C. USB interface or main UART interface (UART is not supported currently).	Real Time Clock	Implemented.
Antenna Interface antenna (active/passive). Size: 32.0±0.15 × 29.0±0.15 × 2.5±0.2 mm. Weight: approx. 4.9 g. Normal operation: -35°C ~ +75°C. Restricted operation: -40°C ~ -35°C and +75°C ~ +85°C ¹⁾ . Storage temperature: -45°C ~ +90°C. USB interface or main UART interface (UART is not supported currently).	Network Indication	
Physical Characteristics Weight: approx. 4.9 g. Normal operation: -35°C ~ +75°C. Restricted operation: -40°C ~ -35°C and +75°C ~ +85°C ¹⁾ . Storage temperature: -45°C ~ +90°C. USB interface or main UART interface (UART is not supported currently).	Antenna Interface	
Temperature Range Restricted operation: -40°C ~ -35°C and +75°C ~ +85°C ¹⁾ . Storage temperature: -45°C ~ +90°C. USB interface or main UART interface (UART is not supported currently).	Physical Characteristics	
currently).	Temperature Range	Restricted operation: -40° C $\sim -35^{\circ}$ C and $+75^{\circ}$ C $\sim +85^{\circ}$ C $^{1)}$.
RoHS All hardware components are fully compliant with EU RoHS directive.	Firmware Upgrade	
	RoHS	All hardware components are fully compliant with EU RoHS directive.

NOTES

- 1. ¹⁾ means when the module works within this temperature range, RF performance might degrade. For example, the frequency error or the phase error would increase.
- 2. "*" means this feature is under development.

2.3. Functional Diagram

The following figure shows a block diagram of UC20 and illustrates the major functional parts.

- Power management
- Baseband
- DDR+NAND flash
- Radio frequency
- Peripheral interface
 - -- UART interface
 - --USIM card interface
 - --USB interface
 - --PCM interface
 - --ADC interface
 - --Status indication
 - -- Control interface



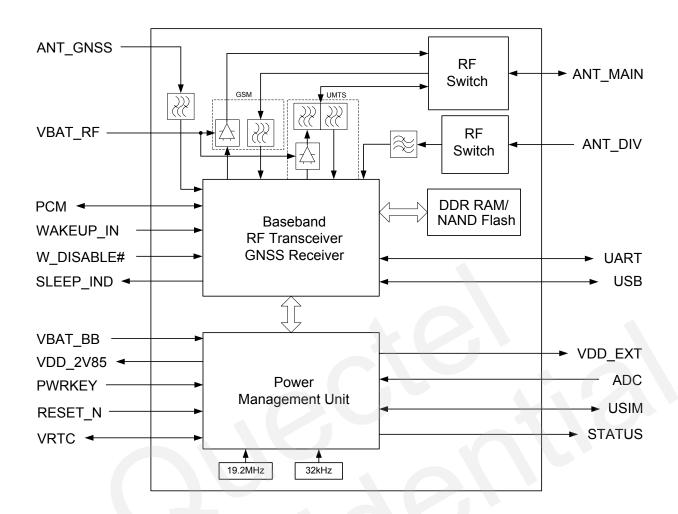


Figure 1: Functional Diagram

2.4. Evaluation Board

In order to help you to develop applications with UC20, Quectel supplies an evaluation board (EVB), RS-232 to USB cable, USB data cable, power adapter, earphone, antenna and other peripherals to control or test the module. For details, please refer to *document* [2].



3 Application Interface

3.1. General Description

UC20 is equipped with a 72-pin 1.3mm pitch SMT pads plus 40-pin ground pads and reserved pads that connect to customer's cellular application platform. Sub-interfaces included in these pads are described in detail in the following chapters:

- Power supply
- UART interface
- USIM interface
- USB interface
- PCM interface
- ADC interface
- Status indication



3.2. Pin Assignment

The following figure shows the pin assignment of the UC20 module.

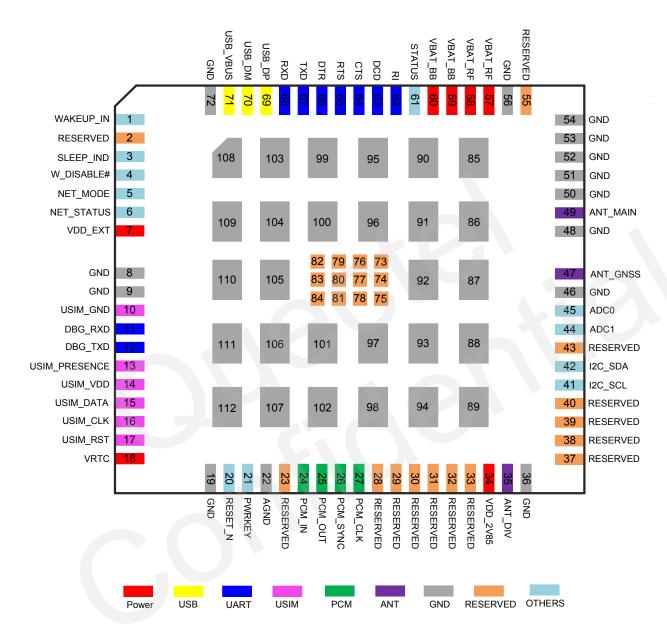


Figure 2: Pin Assignment (Top view)

NOTE

Keep all reserved pins and unused pins unconnected.



3.3. Pin Description

The following tables show the UC20's pin definition.

Table 3: IO Parameters Definition

Туре	Description
Ю	Bidirectional input / output
DI	Digital input
DO	Digital output
PI	Power input
РО	Power output
Al	Analog input
AO	Analog output
OD	Open drain

Table 4: Pin Description

Power Supply					
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
VBAT_BB	59,60	PI	Power supply for module baseband part.	Vmax = 4.3V Vmin = 3.4V Vnorm = 3.8V	It must be able to provide sufficient current up to 0.8A.
VBAT_RF	57,58	PI	Power supply for module RF part.	Vmax = 4.3V Vmin = 3.4V Vnorm = 3.8V	It must be able to provide sufficient current in a transmitting burst which typically rises to 2.0A.
VRTC	18	Ю	Power supply for internal RTC circuit.	V_{O} max = 3.25V when VBAT \geq 3.4V. V_{I} = 1.5V \sim 3.25V at I_{IN} = 3uA when VBAT is not applied.	



NET_ STATUS SLEEP_IND USB Interfa	6 3	DO DO	operating status. Indicate the module network registration mode. Indicate the module network activity status. Indicate the sleep status.	V_{OH} min = 1.35V V_{OL} max = 0.45V V_{OH} min = 1.35V V_{OL} max = 0.45V V_{OH} min = 1.35V V_{OL} max = 0.45V	pull-up. 1.8V power domain. 1.8V power domain. 1.8V power domain.
STATUS	6	DO	Indicate the module network registration mode. Indicate the module network activity status. Indicate the sleep	V_{OL} max = 0.45V V_{OH} min = 1.35V V_{OL} max = 0.45V V_{OH} min = 1.35V	1.8V power domain. 1.8V power domain.
_	5	DO	Indicate the module network registration mode. Indicate the module network activity	V_{OL} max = 0.45V V_{OH} min = 1.35V	1.8V power domain.
			Indicate the module network registration		<u> </u>
NET_MODE		OD	operating status.		pull-up.
STATUS	61	OD	Indicate the module		Require external
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
Status Indic	eation			V_{IH} min = 1.3V V_{IL} max = 500mV	Active low.
RESET_N	20	DI	Reset the module.	$R_{PU} \approx 200$ kΩ V _{IH} max = 2.1V	Pull-up to 1.8V internally.
PWRKEY	21	DI	Turn on/off the module.	$R_{PU} \approx 200 k\Omega$ $V_{IH} max = 2.1 V$ $V_{IH} min = 1.3 V$ $V_{IL} max = 500 mV$	Pull-up to 1.8V internally.
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
Turn On/Off	:				
GND	8,9,19,36, 46,48,50~ 54,56,72, 85~112		Ground.		
VDD_2V85	34	PO	Provide 2.85V for external circuit.	Vnorm = 2.85V I _O max = 100mA	Power supply for external GNSS LNA, active antenna and other circuits.
VDD_EXT	7	РО	Provide 1.8V for external circuit.	$Vnorm = 1.8V$ $I_0max = 20mA$	Power supply for external GPIO's pull up circuits.



USB_VBUS	71	PI	USB detection.	Vmax = 5.5V Vmin = 3.0V Vnorm = 5.0V		
USB_DP	69	Ю	USB differential data bus.	Compliant with USB 2.0 standard specification.	Require differential impedance of 90Ω .	
USB_DM	70	Ю	USB differential data bus.	Compliant with USB 2.0 standard specification.	Require differential impedance of 90Ω .	
USIM Interface						
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment	
USIM_GND	10		Specified ground for USIM card.			
USIM_VDD	14	РО	Power supply for USIM card.	For 1.8V USIM: Vmax = 1.9V Vmin = 1.7V For 3.0V USIM: Vmax = 3.05V Vmin = 2.7V	Either 1.8V or 3V is supported by the module automatically.	
USIM_DATA	15	Ю	Data signal of USIM card.	I_{O} max = 50mA For 1.8V USIM: V_{IL} max = 0.6V V_{IH} min = 1.2V V_{OL} max = 0.45V V_{OH} min = 1.35V For 3V USIM: V_{IL} max = 1.0V V_{IH} min = 1.95V V_{OL} max = 0.45V V_{OH} min = 2.55V	Pull-up to USIM_VDD with 15k resistor internally.	
USIM_CLK	16	DO	Clock signal of USIM card.	For 1.8V USIM: V_{OL} max = 0.45V V_{OH} min = 1.35V For 3V USIM: V_{OL} max = 0.45V V_{OH} min = 2.55V		



LISIM DST	17	DO	Reset signal of	For 1.8V USIM: V_{OL} max = 0.45V V_{OH} min = 1.35V	
USIM_RST	17	БО	USIM card.	For 3V USIM: V_{OL} max = 0.45V V_{OH} min = 2.55V	
USIM_PRE SENCE	13	DI	USIM card input detection.	V_{IL} min = -0.3V V_{IL} max = 0.6V V_{IH} min = 1.2V V_{IH} max = 2.0V	1.8V power domain. Pulled up by default. Active low.
ADC Interfac	е				
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
ADC0	45	Al	General purpose analog to digital converter.	Voltage range: 0.2V to 2.1V	
ADC1	44	Al	General purpose analog to digital converter.	Voltage range: 0.2V to 4.2V	410
Main UART	nterface				
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
RI	62	DO	Ring indicator.	V_{OL} max = 0.45V V_{OH} min = 1.35V	1.8V power domain.
DCD	63	DO	Data carrier detection.	V_{OL} max = 0.45V V_{OH} min = 1.35V	1.8V power domain.
CTS	64	DO	Clear to send.	V_{OL} max = 0.45 V V_{OH} min = 1.35 V	1.8V power domain.
RTS	65	DI	Request to send.	V_{IL} min = -0.3V V_{IL} max = 0.6V V_{IH} min = 1.2V V_{IH} max = 2.0V	1.8V power domain.
DTR	66	DI	Data terminal ready.	V_{IL} min = -0.3V V_{IL} max = 0.6V V_{IH} min = 1.2V V_{IH} max = 2.0V	1.8V power domain. Pull-up by default.
TXD	67	DO	Transmit data.	V_{OL} max = 0.45V V_{OH} min = 1.35V	1.8V power domain.



RXD	68	DI	Receive data.	V_{IL} min = -0.3V V_{IL} max = 0.6V V_{IH} min = 1.2V V_{IH} max = 2.0V	1.8V power domain.
Debug UART	Interface				
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
DBG_TXD	12	DO	Transmit data.	V_{OL} max = 0.45V V_{OH} min = 1.35V	1.8V power domain.
DBG_RXD	11	DI	Receive data.	V_{IL} min = -0.3V V_{IL} max = 0.6V V_{IH} min = 1.2V V_{IH} max = 2.0V	1.8V power domain.
RF Interface					
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
ANT_DIV	35	Al	Diversity antenna.	50Ω impedance	
ANT_MAIN	49	Ю	Main antenna.	50Ω impedance	
ANT_GNSS	47	Al	GNNS antenna.	50Ω impedance	
PCM Interfac	e				
Pin Name	Pin No.	I/O	Description	DC Characteristics	Comment
PCM_IN	24	DI	PCM data input.	V_{IL} min = -0.3V V_{IL} max = 0.6V V_{IH} min = 1.2V V_{IH} max = 2.0V	1.8V power domain.
PCM_OUT	25	DO	PCM data output.	V_{OL} max = 0.45V V_{OH} min = 1.35V	1.8V power domain.
PCM_SYNC	26	Ю	PCM data frame sync signal.	V_{OL} max = 0.45V V_{OH} min = 1.35V V_{IL} min = -0.3V V_{IL} max = 0.6V V_{IH} min = 1.2V V_{IH} max = 2.0V	1.8V power domain. In master mode, it is an output signal. In slave mode, it is an input signal.
PCM_CLK	27	Ю	PCM data bit clock.	V_{OL} max = 0.45V V_{OH} min = 1.35V V_{IL} min = -0.3V V_{IL} max = 0.6V	1.8V power domain. In master mode, it's an output signal. In



22		Reserved for analog ground.	Ground.	If unused, connect this pin to ground.	
Pin No.	I/O	Description	DC Characteristics	Comment	
41	DO	I2C serial clock.	V_{OL} max = 0.45V V_{OH} min = 1.35V	External pull-up resistor is required.	
42	Ю	I2C serial data.	$V_{OL}max = 0.45V$ $V_{OH}min = 1.35V$ $V_{IL}min = -0.3V$ $V_{IL}max = 0.6V$ $V_{IH}min = 1.2V$ $V_{IH}max = 2.0V$	External pull-up resistor is required.	
Other Pins					
Pin No.	I/O	Description	DC Characteristics	Comment	
1	DI	Sleep mode control.	$V_{IL}min = -0.3V$ $V_{IL}max = 0.6V$ $V_{IH}min = 1.2V$ $V_{IH}max = 2.0V$	1.8V power domain. Pull-up by default. Low level wakes up the module.	
4	DI	Airplane mode control.	$V_{IL}min = -0.3V$ $V_{IL}max = 0.6V$ $V_{IH}min = 1.2V$ $V_{IH}max = 2.0V$	1.8V power domain. Pull-up by default. In low level voltage, module can enter into the airplane mode.	
Pins					
Pin No.	I/O	Description	DC Characteristics	Comment	
2,23,28~33 ,37~40,43, 55,73~84		Reserved		Keep these pins unconnected.	
	Pin No. 41 42 Pin No. 1 4 Pins Pin No. 2,23,28~33 ,37~40,43,	Pin No. I/O 41 DO 42 IO Pin No. I/O 1 DI Pins Pin No. I/O 2,23,28~33 ,37~40,43,	Pin No. I/O Description 41 DO I2C serial clock. 42 IO I2C serial data. Pin No. I/O Description 1 DI Sleep mode control. 4 DI Airplane mode control. Pins Pin No. I/O Description 2,23,28~33 3,37~40,43, Reserved	Pin No. I/O Description DC Characteristics	



3.4. Operating Modes

The table below briefly summarizes the various operating modes referred to in the following chapters.

Table 5: Overview of operating modes

Mode	Details	
	GSM Idle	Software is active. The module has registered to the GSM network and is ready to send and receive data.
	GSM Talk/Data	GSM connection is ongoing. In this mode, the power consumption is decided by the configuration of power control level (PCL), dynamic DTX control and the working RF band.
	GPRS Idle	The module is ready for GPRS data transfer, but no data transfer is going on. In this case, power consumption depends on network setting and GPRS configuration.
	GPRS Data	There is GPRS data in transfer (PPP, TCP or UDP). In this mode, power consumption is decided by the PCL, working RF band and GPRS multi-slot configuration.
Normal Operation	EDGE Idle	The module is ready for data transfer in EDGE mode, but no data is currently sent or received. In this case, power consumption depends on network settings and EDGE configuration.
	EDGE Data	There is EDGE data in transfer (PPP, TCP or UDP). In this mode, power consumption is decided by the PCL, working RF band and EDGE multi-slot configuration.
	UMTS Idle	Software is active. The module has registered to the UMTS network and the module is ready to send and receive data.
	UMTS Talk/Data	UMTS connection is ongoing. In this mode, the power consumption is decided by network setting (e.g. TPC pattern) and data transfer rate.
	HSPA Idle	Software is active. The module has registered to the HSPA network and the module is ready to send and receive data.
	HSPA Data	HSPA data transfer is ongoing. In this mode, the power consumption is decided by network setting (e.g. TPC pattern) and data transfer rate.
Minimum Functionality Mode	minimum functio	nmand and W_DISABLE# can set the module entering into a nality mode without removing the power supply. In this case, both USIM card will be invalid.
Sleep Mode		e current consumption of the module will be reduced to the minimal mode, the module can still receive paging message, SMS and voice work normally.



Power Down
Mode

In this mode, the power management unit shuts down the power supply for the baseband part and RF part. Only the power supply for RTC remains. Software is not active. The serial interface is not accessible. Operating voltage (connected to VBAT RF and VBAT BB) remains applied.

3.5. Power Saving

3.5.1. Sleep Mode

UC20 is able to reduce its current consumption to a minimum value during the sleep mode. The following section describes UC20's power saving procedure.

The sleep mode is disabled in default software configuration. There are some preconditions if UC20 want to enter into the sleep mode:

- Execute AT command "AT+QSCLK=1" to enable the sleep mode.
- DTR and WAKEUP_IN pin should be kept high level.
- USB is in suspended state or unconnected state.

Then the module will be able to enter into the sleep mode automatically if there are no on-air interrupt and software programming. During this mode, module can still receive paging, voice call and SMS from network. When the module enters into the sleep mode, the SLEEP_IND will output a high logic level.

3.5.2. Wake up from Sleep Mode

The DTR and WAKEUP_IN pin can be both used to wake up the module from sleep mode. When one of them is driven to low level, the module cannot enter into the sleep mode anymore.

The voice call, SMS and paging message will also wake up the module.

NOTE

The DTR sleep control is enabled in the firmware by default. It can be disabled by AT command. Refer to **document [1]** for details.



3.5.3. Minimum Functionality Mode

Minimum functionality mode reduces the functionality of the module to the minimum level, thus minimizes the current consumption at the same time. This mode can be set with the following ways.

• Hardware:

The W_DISABLE# pin is pulled up by default. When it is driven to low level, the RF function and USIM card do not work. The module will enter into the minimum functionality mode (airplane mode). During this mode, the serial interface is still accessible, but all AT commands correlative with RF function or SIM card function will be not accessible.

Software:

Command "AT+CFUN" provides the choice of the functionality levels <fun> = 0, 1, 4.

AT+CFUN=0: Minimum functionality (airplane mode).

AT+CFUN=1: Full functionality (by default).

AT+CFUN=4: Disable RF function. All AT commands correlative with RF function will be not accessible

For detailed information about "AT+CFUN", please refer to document [1].

NOTES

- The W_DISABLE# control is disabled in firmware by default. It can be enabled by AT command. Refer to document [1].
- When the module is in sleep mode, the W_DISABLE# control is invalid. Please be sure to wake the module up first.
- 3. GNSS function is still available when RF function is disabled.

3.6. Power Supply

3.6.1. Power Supply Pins

UC20 provides four VBAT pins dedicated to connect with the external power supply. There are two separate voltage domains for VBAT.

- VBAT_RF with two pads for module RF part.
- VBAT BB with two pads for module baseband part.

The following table shows the VBAT pins and ground pins.



Table 6: VBAT and GND Pins

Pin Name	Pin No.	Description	Min.	Тур.	Max.	Unit
VBAT_RF	57,58	Power supply for module RF part.	3.4	3.8	4.3	V
VBAT_BB	59,60	Power supply for module baseband part.	3.4	3.8	4.3	V
GND	8,9,19,36,46, 48,50~54,56, 72, 85~112	Ground.	-	0	-	V

3.6.2. Decrease Voltage Drop

The power supply range of the module is $3.4V\sim4.3V$. Because of the voltage drop during the transmitting time, a bypass capacitor of about 100 μ F with low ESR should be used. Multi-layer ceramic chip (MLCC) capacitor can provide the best combination of low ESR. Three ceramic capacitors (100nF, 33pF, 10pF) are recommended to be applied to the VBAT pins. The capacitors should be placed close to the UC20's VBAT pins. The following figure shows star structure of the power supply.

The main power supply from an external application has to be a single voltage source and has to be expanded to two sub paths with star structure. In addition, in order to get a stable power source, it is suggested to use a zener diode of which reverse zener voltage is 5.1V and dissipation power is more than 0.5W.

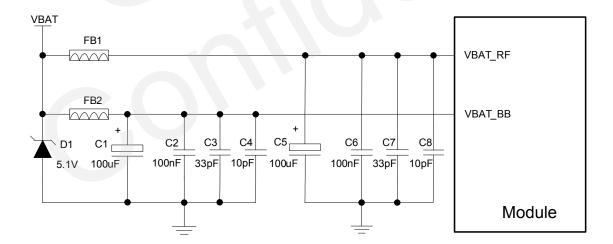


Figure 3: Star Structure of the Power Supply

Please pay special attention to the power supply design for applications. Make sure the input voltage will never drop below 3.4V. If the voltage drops below 3.4V, the module will turn off automatically. The PCB traces from the VBAT pins to the power source must be wide enough to ensure that there isn't too much voltage drop occurs in the transmitting procedure. The width of VBAT_BB trace should be no less than



1mm, and the width of VBAT_RF trace should be no less than 2mm, and the principle of the VBAT trace is the longer, the wider.

3.6.3. Monitor the Power Supply

You can use the "AT+CBC" command to monitor the VBAT_BB voltage value. For more details, please refer to *document* [1].

3.7. Turn on and off Scenarios

3.7.1. Turn on Module Using the PWRKEY

The following table shows the pin definition of PWRKEY.

Table 7: PWRKEY Pin Description

Pin Name	Pin No.	Description	DC Characteristics	Comment
PWRKEY	21	Turn on/off the module.	V_{IH} max = 2.1V V_{IH} min = 1.3V V_{IL} max = 500mV	Pull-up to 1.8V internally with 200k Ω resistor.

When UC20 is in power down mode, it can be turned on to normal mode by driving the PWRKEY pin to a low level at least 100ms. It is recommended to use an open drain/collector driver to control the PWRKEY. You can monitor the level of the STATUS pin to judge whether the module is turned on or not. After STATUS pin (require external pull-up) outputting a low level, PWRKEY pin can be released. A simple reference circuit is illustrated in the following figure.

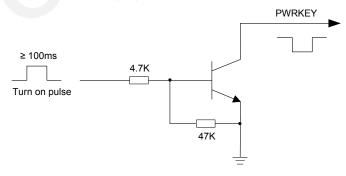


Figure 4: Turn on the Module Using Driving Circuit

The other way to control the PWRKEY is using a button directly. A TVS component is indispensable to be placed nearby the button for ESD protection. When pressing the key, electrostatic strike may generate



from finger. A reference circuit is showed in the following figure.

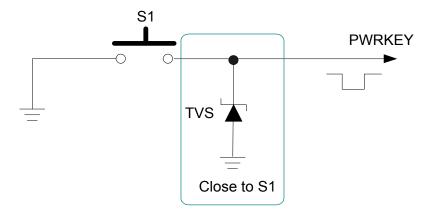


Figure 5: Turn on the Module Using Keystroke

The turn on scenarios is illustrated as the following figure.

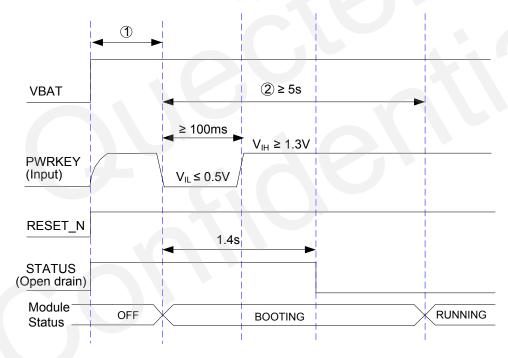


Figure 6: Timing of Turning on Module

NOTES

- 1. Make sure that VBAT is stable before pulling down PWRKEY pin. The time between them is recommended 30ms.
- 2. USB can be used after the software runs.



3.7.2. Turn off Module

The following procedures can be used to turn off the module:

- Normal power down procedure: Turn off the module using the PWRKEY pin.
- Normal power down procedure: Turn off the module using command "AT+QPOWD".
- Automatic shutdown: Turn off the module automatically if under-voltage or over-voltage is detected.

3.7.2.1. Turn off Module Using the PWRKEY Pin

Driving the PWRKEY to a low level voltage at least 0.6s, the module will execute power-down procedure after PWRKEY is released. The power-down scenario is illustrated as the following figure.

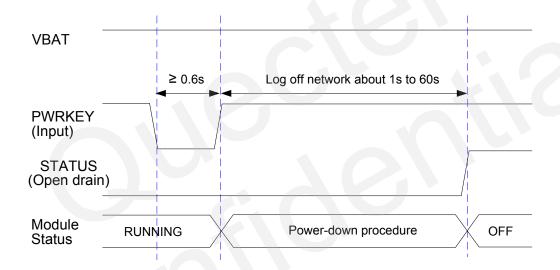


Figure 7: Timing of Turning off Module

During power-down procedure, module will send out URC "NORMAL POWER DOWN" via URC port first, then log off network and save important data. After logging off, module sends out "POWERED DOWN" and shut down the internal power supply. The power on VBAT pins is not allowed to turn off before the URC "POWERED DOWN" is output to avoid data loss. If logging off is not done within 60s, module will shut down internal power supply forcibly.

After that moment, the module enters the power down mode, no other AT commands can be executed and only the RTC is still active. The power down mode can also be indicated by the STATUS pin.



3.7.2.2. Turn off Module Using AT Command

It is also a safe way to use AT command "AT+QPOWD" to turn off the module, which is similar to turning off the module via PWRKEY Pin

Please refer to *document [1]* for details about the AT command of "AT+QPOWD".

3.7.2.3. Automatic Shutdown

The module will constantly monitor the voltage applied on the VBAT, if the voltage \leq 3.5V, the following URC will be presented:

+QIND: "vbatt",-1

If the voltage ≥ 4.21V, the following URC will be presented:

+QIND: "vbatt",1

The uncritical voltage is 3.4V to 4.3V, If the voltage > 4.3V or < 3.4V the module would automatically shut down itself.

If the voltage < 3.4V, the following URC will be presented:

+QIND: "vbatt",-2

If the voltage > 4.3V, the following URC will be presented:

+QIND: "vbatt",2

NOTE

The value of voltage threshold can be revised by AT command, refer to document [1] for details.

3.8. Reset the Module

The RESET N can be used to reset the module.



Table 8: RESET_N pin description

Pin Name	Pin No.	Description	DC Characteristics	Comment
RESET_N	20	Reset the module.	V_{IH} max = 2.1V V_{IH} min = 1.3V V_{IL} max = 500mV	Pull-up to 1.8V internally with $200kΩ$ resistor. Active low.

You can reset the module by driving the RESET_N to a low level voltage for more than 150ms and then releasing.

The recommended circuit is similar to the PWRKEY control circuit. You can use open drain/collector driver or button to control the RESET_N.

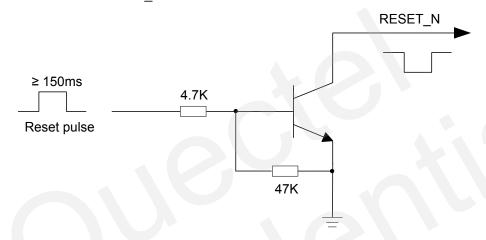


Figure 8: Reference Circuit of RESET_N by Using Driving Circuit

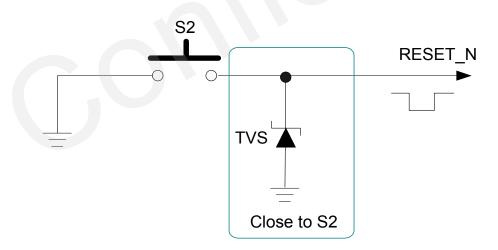


Figure 9: Reference Circuit of RESET_N by Using Button



The reset scenario is illustrated as the following figure.

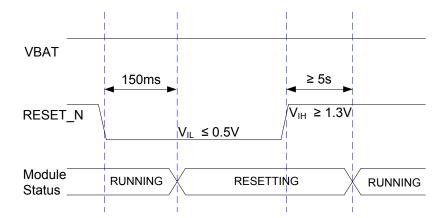


Figure 10: Timing of Resetting Module

NOTE

Use the RESET_N only when turning off the module by the command "AT+QPOWD" and the PWRKEY pin failed.

3.9. RTC Backup

The RTC (Real Time Clock) can be powered by an external power source through the pin VRTC when the module is powered down and there is no power supply for the VBAT. It is also available to charge the battery on the VRTC when module is turned on. You can choose rechargeable battery, capacitor or non-rechargeable battery depending on different applications.

The following figures show the various sample circuits for VRTC backup.

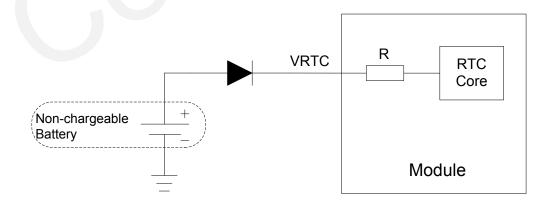


Figure 11: RTC Supply from Non-chargeable Battery



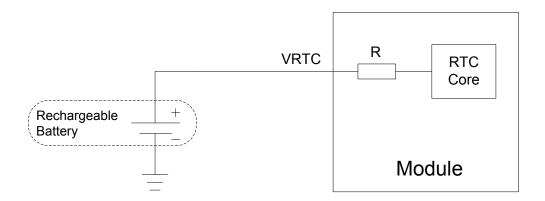


Figure 12: RTC Supply from Rechargeable Battery

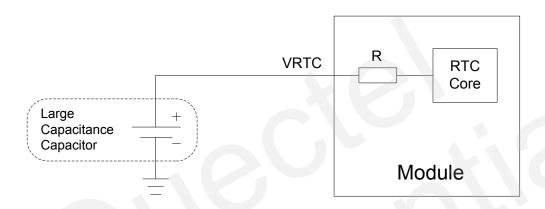


Figure 13: RTC Supply from Capacitor

3.10. UART Interface

The module provides two UART interfaces: main UART interface and debug UART interface. The following shows the different features.

- Main UART interface supports 9600, 19200, 38400, 57600, 115200, 230400, 460800, 921600bps baud rate, the default is 115200bps, while autobauding is not supported. This interface can be used for data transmission, AT communication or firmware upgrade (upgrade is not supported currently).
- Debug UART interface supports 115200bps. It can be used for software debug or GNSS NMEA sentences output.

NOTE

USB interface supports software debug and firmware upgrade by default. It can be revised by AT command, refer to *document [1]* for details.



The module is designed as the DCE (Data Communication Equipment), following the traditional DCE-DTE (Data Terminal Equipment) connection. The following tables show the pin definition of these two UART interfaces.

Table 9: Pin Definition of the Main UART Interface

Pin Name	Pin No.	I/O	Description	Comment
RI	62	DO	Ring indicator.	1.8V power domain.
DCD	63	DO	Data carrier detection.	1.8V power domain.
CTS	64	DO	Clear to send.	1.8V power domain.
RTS	65	DI	Request to send.	1.8V power domain.
DTR	66	DI	Data terminal ready.	1.8V power domain.
TXD	67	DO	Transmit data.	1.8V power domain.
RXD	68	DI	Receive data.	1.8V power domain.

Table 10: Pin Definition of the Debug UART Interface

Pin Name	Pin No.	I/O	Description	Comment
DBG_TXD	12	DO	Transmit data.	1.8V power domain.
DBG_RXD	11	DI	Receive data.	1.8V power domain.

The logic levels are described in the following table.

Table 11: Logic Levels of Digital I/O

Parameter	Min	Max	Unit
V _{IL}	-0.3	0.6	V
V _{IH}	1.2	2.0	V
V _{OL}	0	0.45	V
V _{OH}	1.35	1.8	V



UC20 provides you with a 1.8V UART interface. A level shifter should be used if your application is equipped with a 3.3V UART interface. A level shifter TXB0108PWR provided by **Texas Instruments** is recommended. The following figure shows the reference design of the TXB0108PWR.

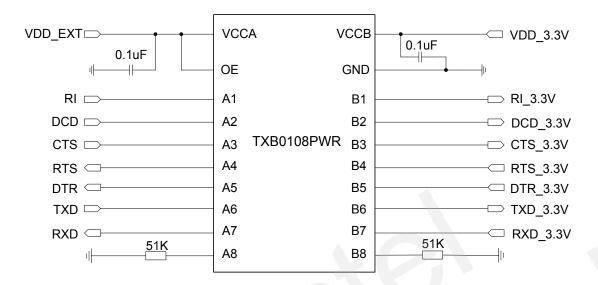


Figure 14: Reference Circuit of Logic Level Translator

Please visit http://www.ti.com for more information.

The following figure is an example of connection between UC20 and PC. A voltage level translator and a RS-232 level translator chip must be inserted between module and PC, since these two UART interfaces do not support the RS-232 level, while support the 1.8V CMOS level only.

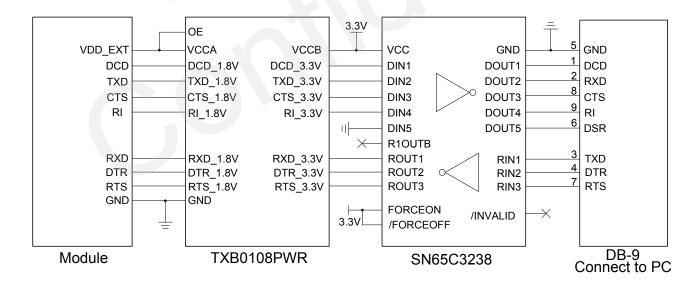


Figure 15: RS232 Level Match Circuit

The following figure shows the reference circuit of debug UART interface with logic level translator. TXB0102DCU provided by *Texas Instruments* is recommended.



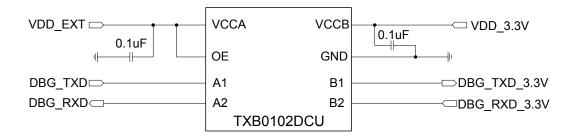


Figure 16: Reference Circuit of Debug UART with Level Translator

Please visit http://www.ti.com for more information.

NOTES

- The module disables the hardware flow control by default. When hardware flow control is required, RTS and CTS should be connected to the host. AT command "AT+IFC=2,2" is used to enable hardware flow control. AT command "AT+IFC=0,0" is used to disable the hardware flow control. For more details, please refer to *document* [1].
- 2. Rising edge on DTR will let the module exit from the data mode by default. It can be disabled by AT commands. Refer to *document* [1] for details.
- 3. DCD is used as data mode indication. Refer to document [1] for details.

3.11. USIM Card Interface

3.11.1. USIM Card Application

The USIM card interface circuitry meets ETSI and IMT-2000 SIM interface requirements. Both 1.8V and 3.0V USIM cards are supported.

Table 12: Pin Definition of the USIM Interface

Pin Name	Pin No.	I/O	Description	Comment
USIM_VDD	14	РО	Power supply for USIM card.	Either 1.8V or 3V is supported by the module automatically.
USIM_DATA	15	Ю	Data signal of USIM card.	Pull-up to USIM_VDD with 15k resistor internally.
USIM_CLK	16	DO	Clock signal of USIM card.	
USIM_RST	17	DO	Reset signal of USIM card.	



USIM_PRES ENCE	13	DI	USIM card detection input.	1.8V power domain.
USIM_GND	10		Specified ground for USIM card.	

The following figure shows the reference design of the 8-pin USIM card.

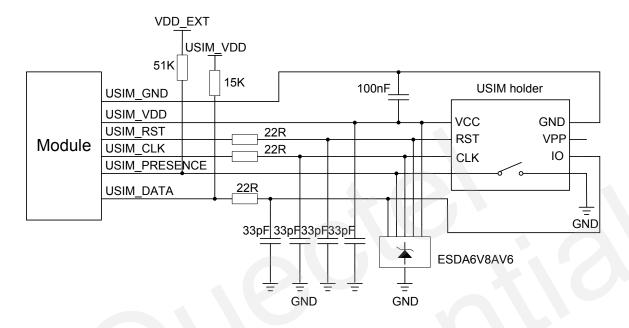


Figure 17: Reference Circuit of the 8 Pin USIM Card

NOTE

Some AT commands are invalid when USIM card is not applied.

UC20 supports USIM card hot-plugging via the USIM_PRESENCE pin. For details, refer to **document [1]**. If you do not need the USIM card detection function, keep USIM_PRESENCE unconnected. The reference circuit for using a 6-pin USIM card socket is illustrated as the following figure.



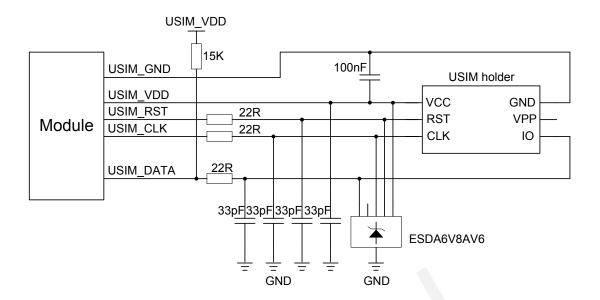


Figure 18: Reference Circuit of the 6 Pin USIM Card

In order to enhance the reliability and availability of the USIM card in customer's application, please follow the following criterion in the USIM circuit design:

- Keep layout of USIM card as close as possible to the module. Assure the possibility of the length of the trace is less than 200mm.
- Keep USIM card signal away from RF and VBAT alignment.
- Assure the ground between module and USIM cassette short and wide. Keep the width of ground and USIM_VDD no less than 0.5mm to maintain the same electric potential. The decouple capacitor of USIM VDD should be less than 1uF and must be near to USIM cassette.
- To avoid cross-talk between USIM_DATA and USIM_CLK, keep them away with each other and shield them with surrounded ground.
- In order to offer good ESD protection, it is recommended to add TVS such as WILL (http://www.willsemi.com) ESDA6V8AV6. The 22Ω resistors should be added in series between the module and the USIM card so as to suppress the EMI spurious transmission and enhance the ESD protection. The 33pF capacitors are used for filtering interference of EGSM900. Please note that the USIM peripheral circuit should be close to the USIM card socket.
- The pull-up resistor on USIM_DATA line can improve anti-jamming capability when long layout trace and sensitive occasion is applied.

3.11.2. Design Considerations for USIM Card Holder

For 8-pin USIM card holder, it is recommended to use Molex 91228. Please visit http://www.molex.com for more information.



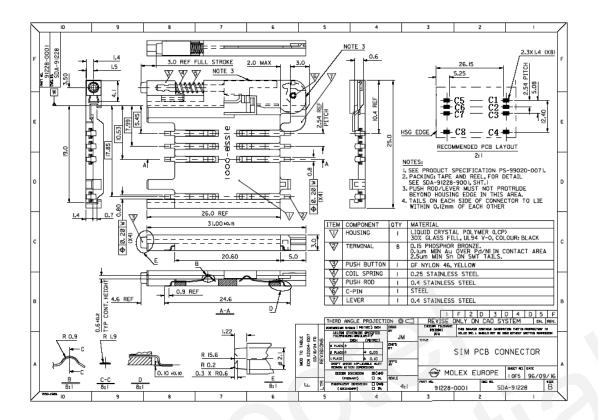


Figure 19: Molex 91228 USIM Card Holder

Table 13: Pin Description of Molex USIM Card Holder

Name	Pin	Function
VDD	C1	USIM card power supply.
RST	C2	USIM card reset.
CLK	C3	USIM card clock.
1	C4	Not defined.
GND	C5	Ground.
VPP	C6	Not connected.
DATA I/O	C7	USIM card data.
1	C8	Pull-down GND with external circuit. When the tray is present, C4 is connected to C8.

For 6-pin USIM card holder, it is recommended to use Amphenol C707 10M006 512 2. Please visit http://www.amphenol.com for more information.



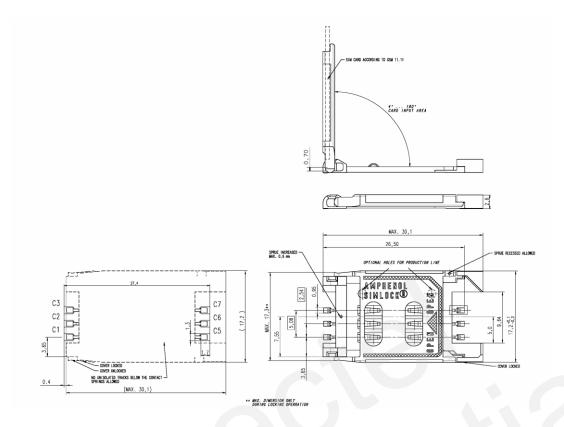


Figure 20: Amphenol C707 10M006 512 2 USIM Card Holder

Table 14: Pin Description of Amphenol USIM Card Holder

Name	Pin	Function
VDD	C1	USIM card power supply.
RST	C2	USIM card reset.
CLK	С3	USIM card clock.
GND	C5	Ground.
VPP	C6	Not connected.
DATA I/O	C7	USIM card data.



3.12. USB Interface

UC20 contains one integrated Universal Serial Bus (USB) transceiver which complies with the USB 2.0 specification and supports high speed (480 Mbps), full speed (12 Mbps) and low speed (1.5 Mbps) mode. The USB interface is primarily used for AT command, data transmission, GNSS NMEA sentences output, software debug and firmware upgrade. The following table shows the pin definition of USB interface.

Table 15: USB Pin Description

Pin Name	Pin No.	I/O	Description	Comment
USB_DP	69	Ю	USB differential data bus (positive).	Require differential impedance of 90Ω.
USB_DM	70	Ю	USB differential data bus (minus).	Require differential impedance of 90Ω.
USB_VBUS	71	PI	Used for detecting the USB interface connected.	3~5.25V. Typical 5.0V.
GND	72		Ground.	

More details about the USB 2.0 specifications, please visit http://www.usb.org/home.

The following figure shows the reference circuit of USB interface.

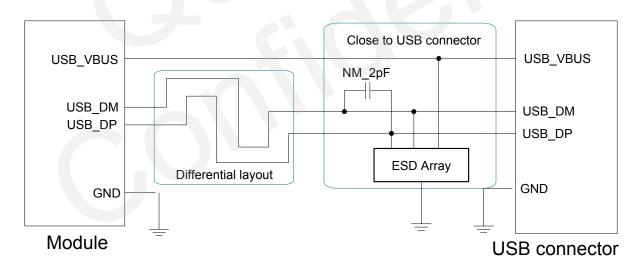


Figure 21: Reference Circuit of USB Application



In order to ensure the USB interface design corresponding with the USB 2.0 specification, please comply with the following principles.

- It is important to route the USB signal traces as differential pairs with total grounding. The impedance of USB differential trace is 90ohm.
- Pay attention to the influence of junction capacitance of ESD component on USB data lines. Typically, the capacitance value should be less than 2pF.
- Do not route signal traces under crystals, oscillators, magnetic devices and RF signal traces. It is
 important to route the USB differential traces in inner-layer with ground shielding not only upper and
 lower layer but also right and left side.
- Keep the ESD components as closer to the USB connector as possible.

NOTE

UC20 module can only be used as a slave device.

3.13. PCM and I2C Interface

UC20 provides one Pulse Code Modulation (PCM) digital interface for audio design, which supports the following modes:

- Primary mode (short sync, works as both master and slave)
- Auxiliary mode (long sync, works as master only)

In primary mode, the data is sampled on the falling edge of the PCM_CLK and transmitted on the rising edge; the PCM_SYNC falling edge represents the MSB. In this mode, PCM_CLK supports 128, 256, 512, 1024, 2048 and 4096kHz for different speech codec.

In auxiliary mode, the data is sampled on the falling edge of the PCM_CLK and transmitted on the rising edge; while the PCM_SYNC rising edge represents the MSB. In this mode, PCM interface operates with a 128 kHz PCM_CLK and an 8 kHz, 50% duty cycle PCM_SYNC only.

UC20 supports 8-bit A-law and μ -law, and also 16-bit linear data formats. The following figures show the primary mode's timing relationship with 8 kHz PCM_SYNC and 2048 kHz PCM_CLK and auxiliary mode's timing relationship with 8 kHz PCM_SYNC and 128 kHz PCM_CLK.

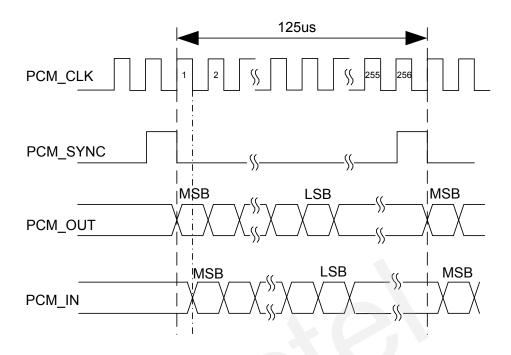


Figure 22: Primary Mode Timing

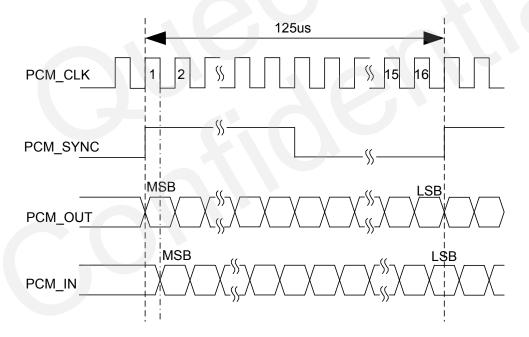


Figure 23: Auxiliary Mode Timing

The following table shows the pin definition of PCM and I2C interface which can be applied on audio codec design.



Table 16: Pin Definition of PCM and I2C Interface

Pin Name	Pin No.	I/O	Description	Comment
PCM_IN	24	DI	PCM data input.	1.8V power domain.
PCM_OUT	25	DO	PCM data output.	1.8V power domain.
PCM_SYNC	26	Ю	PCM data frame sync signal.	1.8V power domain.
PCM_CLK	27	Ю	PCM data bit clock.	1.8V power domain.
I2C_SCL	41	DO	I2C serial clock.	Require external pull-up resistor.
I2C_SDA	42	IO	I2C serial data.	Require external pull-up resistor.

Clock and mode can be configured by AT command, and the default configuration is master mode using short sync data format with 2048 kHz PCM_CLK and 8 kHz PCM_SYNC. In addition, UC20's firmware has integrated the configuration on NAU8814 application with I2C interface. Refer to *document [1]* for details.

The following figure shows the reference design of PCM interface with external codec IC.

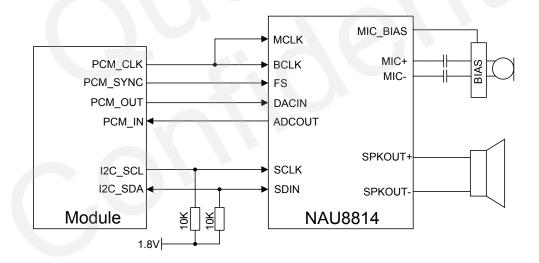


Figure 24: Reference Circuit of PCM Application with Audio Codec

NOTES

- 1. It is recommended to reserved RC (R=22 Ω , C=22pF) circuit on the PCM lines, especially for PCM_CLK.
- 2. UC20 work as a master device pertaining to I2C interface.



3.14. ADC Function

The module provides two analog-to-digital converters (ADC) to digitize the analog signal to 15-bit digital data such as battery voltage, temperature and so on. Using AT command "AT+QADC=0" can read the voltage value on ADC0 pin. Using AT command "AT+QADC=1" can read the voltage value on ADC1 pin. For more details of these AT commands, please refer to **document [1]**.

In order to improve the accuracy of ADC, the trace of ADC should be surrounded by ground.

Table 17: Pin Definition of the ADC

Pin name	Pin NO.	Description
ADC0	45	General purpose analog to digital converter.
ADC1	44	General purpose analog to digital converter.

The following table describes the characteristic of the ADC function.

Table 18: Characteristic of the ADC

Item	Min	Тур.	Max	Unit
ADC0 voltage range	0.2		2.1	V
ADC1 voltage range	0.2		4.2	V
ADC resolution		15		bits
Offset error		3.5		%
Gain error		2.5		%

3.15. Network Status Indication

The network indication pins can be used to drive a network status indicator LED. The module provides two pins which are NET_MODE and NET_STATUS. The following tables describe pin definition and logic level changes in different network status.



Table 19: Pin Definition of Network Indicator

Pin Name	Pin No.	I/O	Description	Comment
NET_MODE	5	DO	Indicate the module network registration mode.	1.8V power domain.
NET_STATUS	6	DO	Indicate the module network activity status.	1.8V power domain.

Table 20: Working State of the Network Indicator

Pin name	Status	Description
NET MODE	Always High.	Registered in 3G network.
NET_MODE	Always Low.	Others.
	Flicker slowly (200ms High/1800ms Low).	Networks searching.
NET STATUS	Flicker slowly (1800ms High/200ms Low).	ldle.
NET_STATUS	Flicker quickly (125ms High/125ms Low).	Data transfer is ongoing.
	Always High.	Voice calling.

A reference circuit is shown in the following figure.

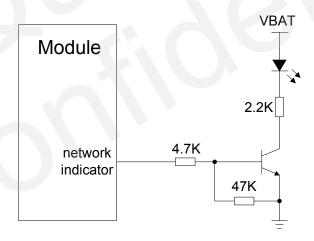


Figure 25: Reference Circuit of the Network Indicator

3.16. Operating Status Indication

3.16.1. STATUS

The STATUS pin is an open drain output for indicating the module operation status. You can connect it to



a GPIO of DTE with pulled up, or as LED indication circuit as below. When the module is turned on normally, the STATUS will present the low state. Otherwise, the STATUS will present high-impedance state.

Table 21: Pin Definition of STATUS

Pin Name	Pin No.	I/O	Description	Comment
STATUS	61	OD	Indicate the module operation status.	Require external pull-up.

The following figure shows different design circuit of STATUS, you can choose either one according to your application demands.

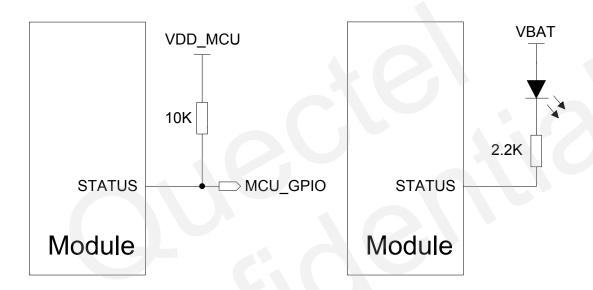


Figure 26: Reference Circuit of the STATUS

3.16.2. **SLEEP_IND**

The SLEEP_IND is an indicated pin for judging whether the module is in sleep mode or not. When the module enters into the sleep mode, the SLEEP_IND will output a logic high level. So you can use the SLEEP_IND for low current indication. The following table shows the pin definition of SLEEP_IND.

Table 22: Pin Definition of SLEEP_IND

Pin Name	Pin No.	I/O	Description	Comment
SLEEP_IND	3	DO	Indicate the sleep status.	1.8V power domain. Outputs high level when the module is in sleep mode.



A reference circuit is shown in the following figure.

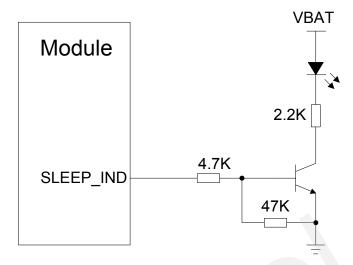


Figure 27: Reference Circuit of the SLEEP_IND

3.17. Behavior of the RI

The URC is output through USB AT port by default, and it can be revised by AT command. Refer to **document [1]** for details.

When the URC output port is set to the main UART port, there will be the following responses by default on RI pin, and the behavior can be either revised by AT command. Refer to **document [1]** for details.

Table 23: Behavior of the RI

State	Response
Idle	RI keeps high level.
URC	RI outputs 120ms low pulse when new URC returns.



4 GNSS Receiver

4.1. General Description

UC20 includes a fully integrated global navigation satellite system solution that supports the latest generation gpsOne GEN8 of Qualcomm (GPS and GLONASS). Compared with GPS only, dual systems increase usable constellation, reduce coverage gaps and TTFF, and increase positioning accuracy, especially in rough urban environments.

UC20 works in standalone mode, allows device to demodulate GNSS assistance data, calculate position without any assistance from the network, suitable for various application needing lowest-cost, accurate position determination. UC20 supports Qualcomm gpsOneXTRA technology (one kind of A-GNSS), which will download XTRA file from the internet server to enhance the TTFF. XTRA file contains predicted GPS and GLONASS satellites coordinates and clock biases valid for up to 7days. It is the best if XTRA file is downloaded once every 1-2 days. And UC20 also supports SBAS (including WAAS, ENGOS and MSAS), which will improve fix accuracy.

UC20 provides power-saving solution named DPO (Dynamic Power Optimization), which attempts to turn off GNSS RF parts, reduces current consumption by 50% at most without impact on TTFF and extends battery life, maximizes talk and standby time as well.

UC20 supports standard NMEA-0183 protocol, and outputs NMEA sentences with 1Hz via USB interface by default.

By default, UC20 GNSS engine is switched off, it has to be switched on with AT command. For more details about GNSS engine technology and configurations, refer to *document* [7].



4.2. GNSS Performance

The following table shows UC20 GNSS performance.

Table 24: GNSS Performance

Parameter	Description	Conditions	Тур.	Unit
	Cold start	Autonomous	-144	dBm
	Cold Start	With LNA	-147	dBm
Sensitivity	Acquicition	Autonomous	-154	dBm
(GNSS)	Acquisition	With LNA	-159	dBm
	Tracking	Autonomous	-155	dBm
		With LNA	-160	dBm
	Cold start @open sky Warm start @open sky	Autonomous	32	S
		XTRA enabled	22	S
TTFF		Autonomous	29	S
(GNSS)		XTRA enabled	3	S
	Hot start	Autonomous	2.5	S
	@open sky	XTRA enabled	2	S
Accuracy (GNSS)	CEP-50	Autonomous @open sky	<1.5	m

NOTES

- 1. Tracking sensitivity: The lowest GPS signal level at the antenna port which the module fails to fix.
- 2. Acquisition sensitivity: The lowest GPS signal level at the antenna port which the module fixes.
- 3. Cold start sensitivity: The lowest GPS signal level at the antenna port which the module fixes by executing cold start command.



4.3. Layout Guideline

The following layout guideline should be taken into account in your design.

- Maximize the distance between the GNSS antenna and the main GSM/UMTS antenna.
- Noisy digital circuits such as the SIM card, USB interface, Camera module, Display connector and SD card should be away from the antenna.
- Use ground vias around the GNSS trace and sensitive analog signal traces to provide coplanar isolation and protection.
- Keep 50 ohm characteristic impedance of the ANT GNSS trace.

Refer to chapter 5 for GNSS reference design and antenna consideration.



5 Antenna Interface

UC20 antenna interface includes a main GSM/UMTS antenna, an optional UMTS Rx-diversity antenna, which is used for improve UMTS's receiving performance, and a GNSS antenna. The antenna interface has an impedance of 50Ω .

5.1. GSM/UMTS Antenna Interface

5.1.1. Pin Definition

The main antenna and UMTS Rx-diversity antenna pins definition are shown below.

Table 25: Pin Definition of the RF Antenna

Pin Name	Pin No.	I/O	Description	Comment
ANT_MAIN	49	10	Main antenna	50Ω impedance
ANT_DIV	35	Al	Diversity antenna	50Ω impedance

5.1.2. Operating Frequency

Table 26: The Module Operating Frequencies

Band	Receive	Transmit	Unit
GSM850	869 ~ 894	824 ~ 849	MHz
EGSM900	925 ~ 960	880 ~ 915	MHz
DCS1800	1805 ~ 1880	1710 ~ 1785	MHz
PCS1900	1930 ~ 1990	1850 ~ 1910	MHz
UMTS 2100	2110 ~ 2170	1920 ~ 1980	MHz



UMTS 1900	1930 ~ 1990	1850 ~ 1910	MHz
UMTS 900	925 ~ 960	880 ~ 915	MHz
UMTS 850	869 ~ 894	824 ~ 849	MHz

5.1.3. Reference Design

The reference design of main antenna and UMTS Rx-diversity antenna is shown as below. It should reserve a π -type matching circuit for better RF performance. The capacitors are not mounted by default.

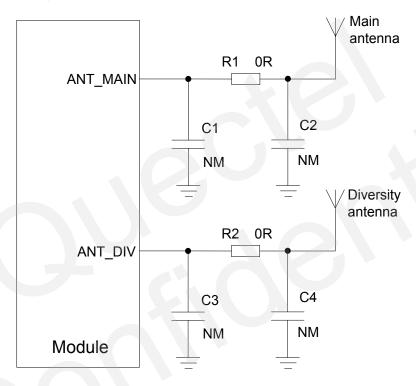


Figure 28: Reference Circuit of Antenna Interface

NOTE

Keep a proper distance between main antenna and diversity antenna to improve the receiving sensitivity.



5.2. GNSS Antenna Interface

The following tables show the GNSS antenna pin definition and frequency specification.

Table 27: Pin Definition of GNSS Antenna

Pin Name	Pin No.	I/O	Description	Comment
ANT_GNSS	47	Al	GNSS antenna	50Ω impedance
VDD_2V85	34	РО	Power for external LNA.	Vnorm=2.85V

Table 28: GNSS Frequency

Туре	Frequency	Unit
GPS	1575.42±1.023	MHz
GLONASS	1597.5~1605.8	MHz

5.2.1. Reference Design for Passive Antenna

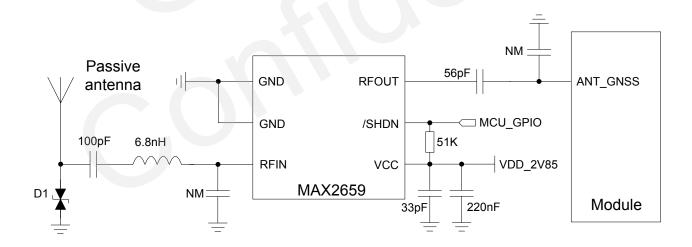


Figure 29: Reference Circuit of GNSS Passive Antenna



5.2.2. Reference Design for Active Antenna

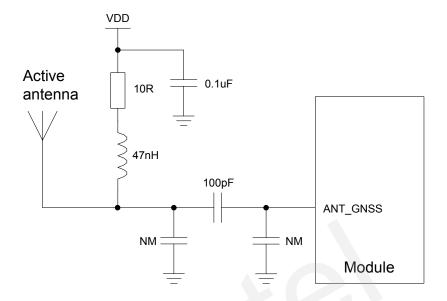


Figure 30: Reference Circuit of GNSS Active Antenna

NOTES

- You can choose the corresponding reference circuit above according to your demands on antenna circuit design.
- 2. MAX2659 is the recommended LNA chip. You can disable LNA to save power with one GPIO shown in above figure. Pay attention to this pin's voltage level.
- 3. In Figure 30, VDD supplies power for active antenna. You can choose the right VDD according to the requirements for active antenna. This power circuit is not needed if passive antenna is applied here.
- 4. All NM capacitors are reserved for adjusting RF performance.
- 5. The capacitance of ESD component D1 should be less than 1pF.

5.3. Antenna Installation

5.3.1. Antenna Requirement

The following table shows the requirement on GSM/UMTS antenna and GNSS antenna.



Table 29: Antenna Requirements

Туре	Requirements
	Frequency range: 1565~1607 MHz Polarization: RHCP or linear VSWR: <2 (Typ.)
GNSS	Passive antenna gain: >0dBi Active antenna noise figure: <1.5dB Active antenna gain: >-2dBi Active antenna embedded LNA gain: 20dB (Typ.)
	Active antenna total gain: >18dBi (Typ.)
GSM850/EGSM900 UMTS 850/900	Cable insertion loss < 1dB
DCS1800/PCS1900 UMTS 1900/2100	Cable insertion loss < 1.5dB

5.3.2. Install the Antenna with RF Connector

The following is the antenna installation with RF connector provided by HIROSE. The recommended RF connector is UF.L-R-SMT.

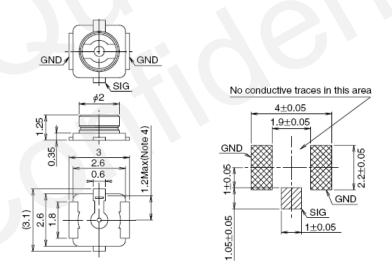


Figure 31: Dimensions of the UF.L-R-SMT Connector (Unit: mm)

You can use U.FL-LP serial connector listed in the following figure to match the UF.L-R-SMT.

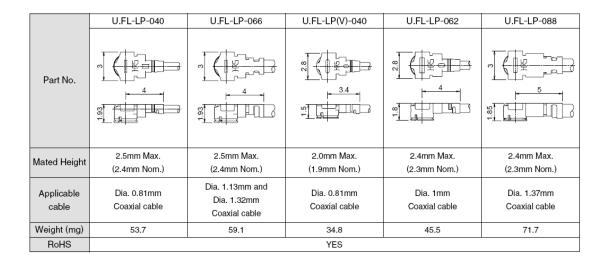


Figure 32: Mechanicals of UF.L-LP Connectors (Unit: mm)

The following figure describes the space factor of mated connector

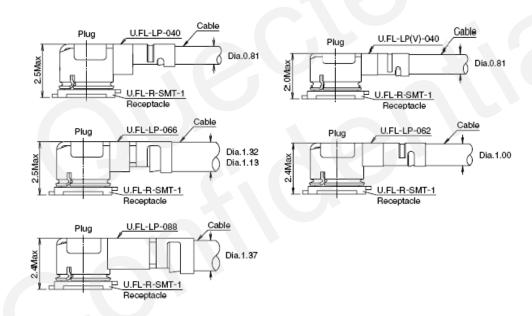


Figure 33: Space Factor of Mated Connector (Unit: mm)

For more details, please visit http://www.hirose.com.



6 Electrical, Reliability and Radio Characteristics

6.1. Absolute Maximum Ratings

Absolute maximum ratings for power supply and voltage on digital and analog pins of module are listed in the following table:

Table 30: Absolute Maximum Ratings

Parameter	Min	Max	Unit
VBAT_RF/VBAT_BB	-0.3	4.7	V
USB_VBUS	-0.3	5.5	V
Peak current of VBAT_BB	0	0.8	А
Peak current of VBAT_RF	0	1.8	А
Voltage at digital pins	-0.3	2.3	V
Voltage at ADC0	0	2.1	V
Voltage at ADC1	0	4.2	V

6.2. Power Supply Ratings

Table 31: The Module Power Supply Ratings

Parameter	Description	Conditions	Min	Тур.	Max	Unit
VBAT	VBAT_BB and VBAT_RF	Voltage must stay within the min/max values, including voltage drop, ripple, and spikes.	3.4	3.8	4.3	V



Parameter	Description	Conditions	Min	Тур.	Max	Unit
	Voltage drop during transmitting burst	Maximum power control level on GSM850 and EGSM900.			400	mV
I _{VBAT}	Peak supply current (during transmission slot)	Maximum power control level on GSM850 and EGSM900.		1.8	2.0	А
USB_VBUS	USB detection		3.0	5.0	5.25	V

6.3. Operating Temperature

The operating temperature is listed in the following table.

Table 32: Operating Temperature

Parameter	Min	Тур.	Max	Unit
Normal Temperature	-35	25	75	°C
Restricted Operation ¹⁾	-40~ -35		75 ~ 85	°C
Storage Temperature	-45		90	°C

NOTE

¹⁾ When the module works within the temperature range, the deviations from the RF specification may occur. For example, the frequency error or the phase error would increase.



6.4. Current Consumption

The values of current consumption are shown below.

Table 33: The Module Current Consumption

Parameter	Description	Conditions	Min	Тур.	Max	Unit
	OFF state supply current	Power down		45		uA
	OOM/ODDO	Sleep (USB disconnected) @ DRX=2		2.1		mA
	GSM/GPRS supply current (GNSS off)	Sleep (USB disconnected) @ DRX=5		1.6		mA
	(61133 011)	Sleep (USB disconnected) @ DRX=9		1.5		mA
		Sleep (USB disconnected) @ DRX=6		2.0		mA
		Sleep (USB disconnected) @ DRX=7		1.7		mA
	WCDMA supply current (GNSS off)	Sleep (USB disconnected) @ DRX=8		1.5		mA
		Sleep (USB disconnected) @ DRX=9		1.4		mA
I_{VBAT}		Idle (USB disconnected) @ DRX=6		14.0		mA
		Idle (USB connected) @ DRX=6		33.4		mA
		GSM850 1DL/1UL PCL=5		260		mA
		GSM850 4DL/1UL PCL=5		280		mA
		GSM850 3DL/2UL PCL=5		440		mA
	GPRS data	GSM850 2DL/3UL PCL=5		550		mA
	transfer (GNSS off)	GSM850 1DL/4UL PCL=5		540		mA
		EGSM900 1DL/1UL PCL=5		240		mA
		EGSM900 4DL/1UL PCL=5		250		mA
		EGSM900 3DL/2UL PCL=5		390		mA



Parameter	Description	Conditions	Min	Тур.	Max	Unit
		EGSM900 2DL/3UL PCL=5		510		mA
		EGSM900 1DL/4UL PCL=5		500		mA
		DCS1800 1DL/1UL PCL=0		230		mA
		DCS1800 4DL/1UL PCL=0		250		mA
		DCS1800 3DL/2UL PCL=0		370		mA
	GPRS data	DCS1800 2DL/3UL PCL=0		480		mA
	transfer (GNSS	DCS1800 1DL/4UL PCL=0		500		mA
	off)	PCS1900 1DL/1UL PCL=0		200		mA
		PCS1900 4DL/1UL PCL=0		220		mA
		PCS1900 3DL/2UL PCL=0		345		mA
		PCS1900 2DL/3UL PCL=0		450		mA
		PCS1900 1DL/4UL PCL=0		480		mA
	EDGE data	GSM850 1DL/1UL PCL=8		170		mA
		GSM850 4DL/1UL PCL=8		187		mA
		GSM850 3DL/2UL PCL=8		254		mA
		GSM850 2DL/3UL PCL=8		317		mA
		GSM850 1DL/4UL PCL=8		383		mA
		EGSM900 1DL/1UL PCL=8		167		mA
	transfer (GNSS off)	EGSM900 4DL/1UL PCL=8		182		mA
		EGSM900 3DL/2UL PCL=8		249		mA
		EGSM900 2DL/3UL PCL=8		312		mA
		EGSM900 1DL/4UL PCL=8		378		mA
		DCS1800 1DL/1UL PCL=2		182		mA
		DCS1800 4DL/1UL PCL=2		201		mA



Parameter	Description	Conditions	Min	Тур.	Max	Unit
		DCS1800 3DL/2UL PCL=2		273		mA
		DCS1800 2DL/3UL PCL=2		341		mA
		DCS1800 1DL/4UL PCL=2		414		mA
	EDGE data	PCS1900 1DL/1UL PCL=2		170		mA
	transfer (GNSS	PCS1900 4DL/1UL PCL=2		191		mA
	off)	PCS1900 3DL/2UL PCL=2		252		mA
		PCS1900 2DL/3UL PCL=2		309		mA
		PCS1900 1DL/4UL PCL=2		367		mA
		UMTS2100 HSDPA		517		mA
	WCDMA data	UMTS2100 HSUPA		497		mA
	transfer (GNSS off)	UMTS900 HSDPA		429		mA
		UMTS900 HSUPA		429		mA
		GSM850 @PCL=5		249		mA
		GSM850 @PCL=12		130		mA
		GSM850 @PCL=19		101		mA
		EGSM900 @PCL=5		284		mA
		EGSM900 @PCL=12		132		mA
	0014	EGSM900 @PCL=19		104		mA
	GSM voice call	DCS1800 @PCL=0		249		mA
		DCS1800 @PCL=7		114		mA
		DCS1800 @PCL=15		105		mA
		PCS1900 @PCL=0		217		mA
		PCS1900 @PCL=7		126		mA
		PCS1900 @PCL=15		109		mA



Parameter	Description	Conditions	Min	Тур.	Max	Unit
	WCDMA voice	UMTS2100		445		mA
call	UMTS900		387		mA	
	GNSS Off			33.4		mA
	Cold Start (Autonomous)	Idle, USB connected, AT+CFUN=0 @DRX=6		80.6		mA
	Tracking (Autonomous)	<u>-</u>		71.2		mA

NOTE

GNSS tracking current is tested in the following conditions:

- For Cold Start, 10 minutes after First Fix.
- For Hot Start, 15 seconds after First Fix.

6.5. RF Output Power

The following table shows the RF output power of UC20 module.

Table 34: Conducted RF Output Power

Frequency	Max	Min
GSM850	33dBm ±2dB	5dBm±5dB
EGSM900	33dBm ±2dB	5dBm±5dB
DCS1800	30dBm ±2dB	0dBm±5dB
PCS1900	30dBm ±2dB	0dBm±5dB
GSM850(8-PSK)	27dBm ±3dB	5dBm±5dB
EGSM900(8-PSK)	27dBm ±3dB	5dBm±5dB
DCS1800(8-PSK)	26dBm ±3dB	0dBm±5dB
PCS1900(8-PSK)	26dBm ±3dB	0dBm±5dB
UMTS 2100	24dBm+1/-3dB	<-50dBm
UMTS 1900	24dBm+1/-3dB	<-50dBm



UMTS 900	24dBm+1/-3dB	<-50dBm
UMTS 850	24dBm+1/-3dB	<-50dBm

NOTE

In GPRS 4 slots TX mode, the max output power is reduced by 2.5dB. This design conforms to the GSM specification as described in chapter 13.16 of 3GPP TS 51.010-1.

6.6. RF Receiving Sensitivity

The following table shows the conducted RF receiving sensitivity of UC20 module.

Table 35: Conducted RF Receiving Sensitivity

Frequency	Receive Sensitivity (Typ.)
GSM850	-108.5dBm
EGSM900	-108.5dBm
DCS1800	-108dBm
PCS1900	-108dBm
UMTS 2100	-110dBm
UMTS 1900	-110dBm
UMTS 900	-110dBm
UMTS 850	-110dBm

6.7. Electrostatic Discharge

The module is not protected against electrostatics discharge (ESD) in general. Consequently, it is subject to ESD handling precautions that typically apply to ESD sensitive components. Proper ESD handling and packaging procedures must be applied throughout the processing, handling and operation of any application that incorporates the module.



The following table shows the module electrostatics discharge characteristics.

Table 36: Electrostatics Discharge Characteristics

Tested Points	Contact discharge	Air Discharge	Unit
VBAT, GND	±5	±10	kV
All antenna interfaces	±4	±8	kV
Other interfaces	±0.5	±1	kV



7 Mechanical Dimensions

This chapter describes the mechanical dimensions of the module. All dimensions are measured in mm.

7.1. Mechanical Dimensions of the Module

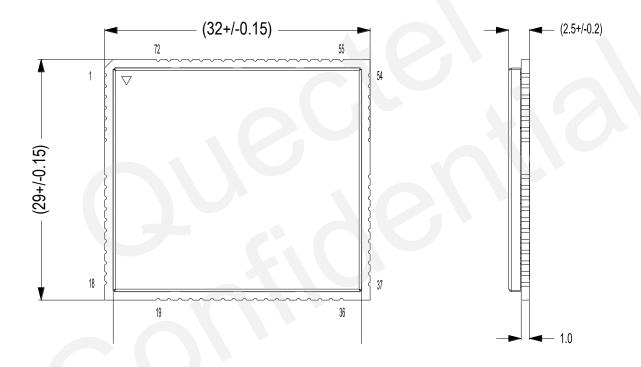


Figure 34: UC20 Top and Side Dimensions



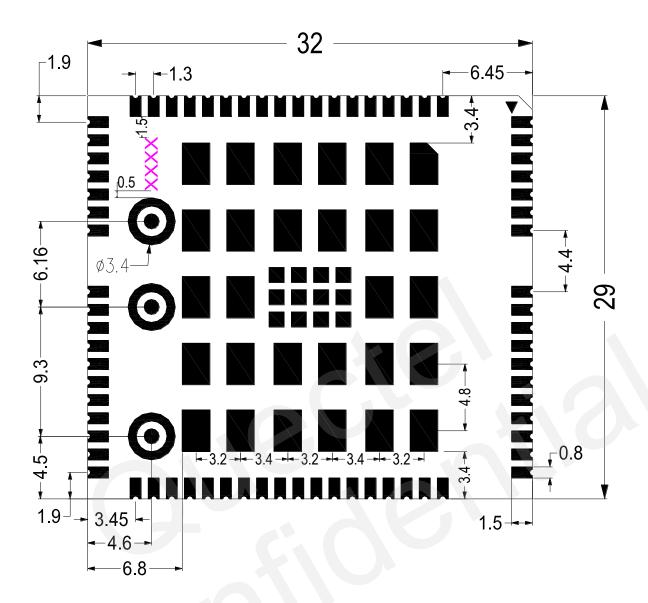


Figure 35: UC20 Bottom Dimensions (Bottom view)

NOTE

"XXXX" in pink on above figure is the PCB board code in the exposed copper.

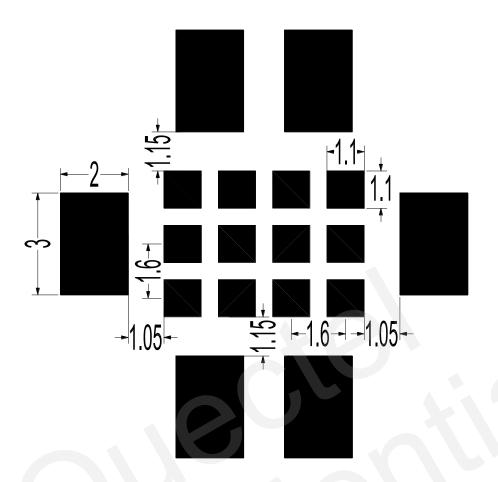


Figure 36: Bottom Pads Dimensions (Bottom view)



7.2. Footprint of Recommendation

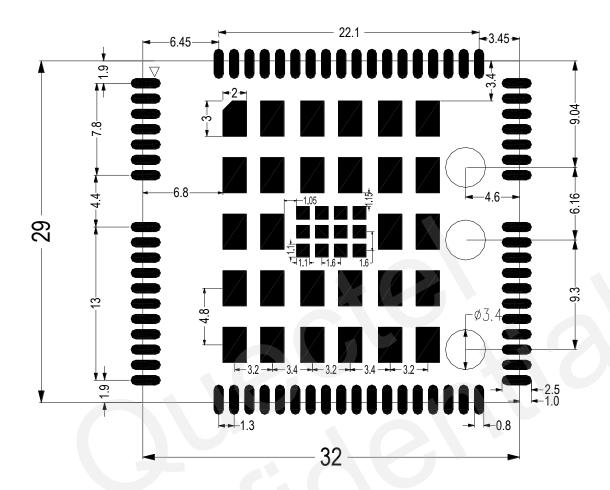


Figure 37: Recommended Footprint (Top view)

NOTES

- 1. Keep out the area below the test point (circular area on the above figure) in the host PCB.
- 2. In order to maintain the module, keep about 3mm between the module and other components in the host PCB.



7.3. Top View of the Module



Figure 38: Top View of the Module

7.4. Bottom View of the Module

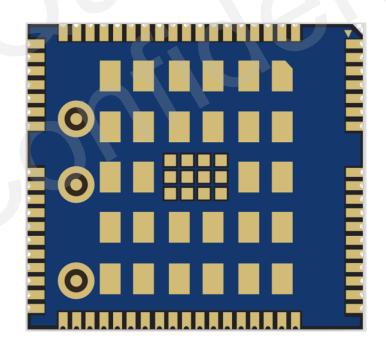


Figure 39: Bottom View of the Module



8 Storage and Manufacturing

8.1. Storage

UC20 is stored in the vacuum-sealed bag. The restriction of storage condition is shown as below.

Shelf life in sealed bag is 12 months at < 40°C / 90%RH.

After this bag is opened, devices that will be subjected to reflow solder or other high temperature process must be:

- Mounted within 72 hours at factory conditions of ≤ 30°C / 60%RH.
- Stored at <10% RH.

Devices require bake, before mounting, if:

- Humidity indicator card is >10% when read 23°C ± 5°C.
- Mounted for more than 72 hours at factory conditions of ≤ 30°C / 60% RH.

If baking is required, devices may be baked for 48 hours at $125^{\circ}\text{C} \pm 5^{\circ}\text{C}$.

NOTE

As plastic container cannot be subjected to high temperature, Module needs to be taken out from container to high temperature (125°C) bake. If shorter bake times are desired, please refer to IPC/JEDECJ-STD-033 for bake procedure.

8.2. Manufacturing and Welding

The squeegee should push the paste on the surface of the stencil that makes the paste fill the stencil openings and penetrate to the PCB. The force on the squeegee should be adjusted so as to produce a clean stencil surface on a single pass. To ensure the module soldering quality, the thickness of stencil at the hole of the module pads should be 0.18mm. For details, please refer to **document [6]**.

It is suggested that peak reflow temperature is 235 ~ 245°C (for SnAg3.0Cu0.5 alloy). Absolute max



reflow temperature is 260°C. To avoid damage to the module when it was repeatedly heated, it is suggested that the module should be mounted after the first panel has been reflowed. The following picture is the actual diagram which we have operated.

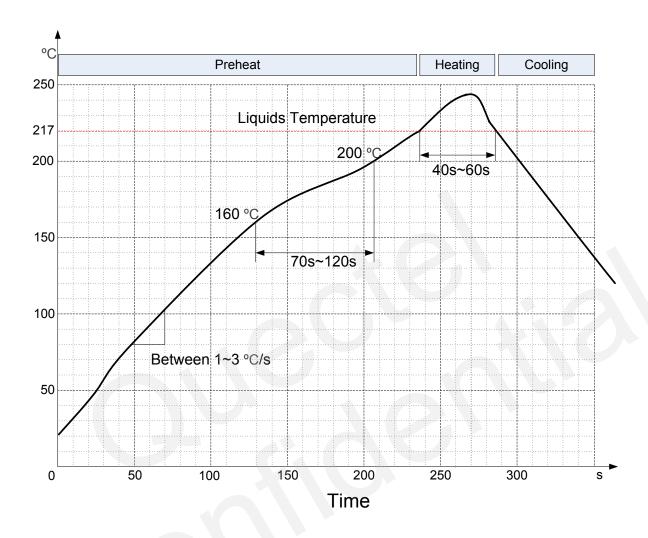


Figure 40: Liquids Temperature

8.3. Packaging

UC20 is packaged in the tap and reel carriers. One reel is 11.53m length and contains 250pcs modules. The figure below shows the package details.



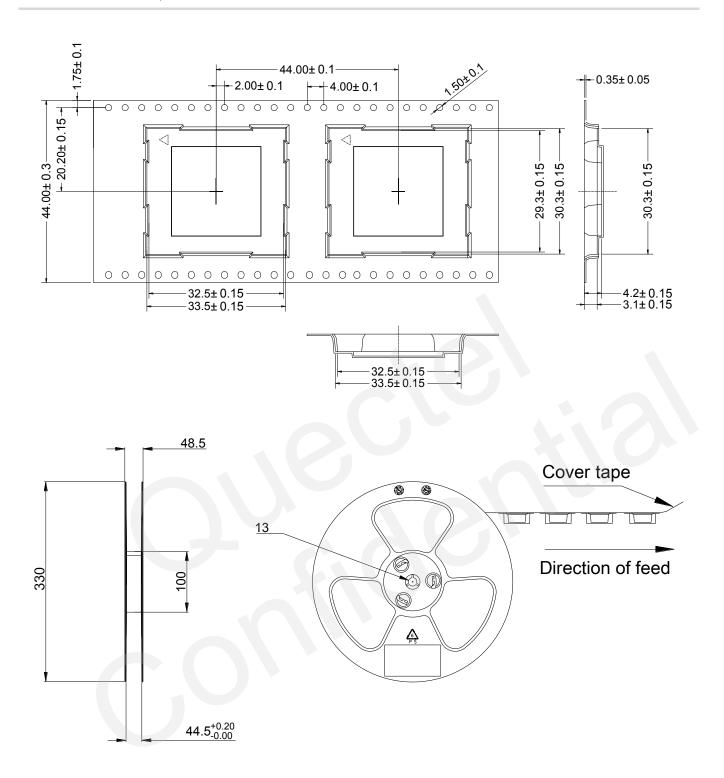


Figure 41: Carrier Tape



9 Appendix A Reference

Table 37: Related Documents

SN	Document name	Remark
[1]	UC20_AT_Commands_Manual	UC20 AT Commands Manual
[2]	UC20_EVB_User_Guide	UC20 EVB User Guide
[3]	UC20_Reference_Design	UC20 Reference Design
[4]	UC20&M10_Reference_Design	UC20 and M10 Compatible Reference Design
[5]	UC20&M10_Compatibilty_Design	UC20 and M10 Compatibility Design Specification
[6]	Module_Secondary_SMT_User_Guide	Module Secondary SMT User Guide
[7]	UC20_GNSS_AT_Commands_Manual	UC20 GNSS AT Commands Manual

Table 38: Terms and Abbreviations

Abbreviation	Description
AMR	Adaptive Multi-rate
ARP	Antenna Reference Point
bps	bits per second
CHAP	Challenge Handshake Authentication Protocol
CMUX	Customer
CS	Coding Scheme
CSD	Circuit Switched Data
CTS	Clear To Send
DRX	Discontinuous Reception



DCE	Data Communications Equipment (typically module)
DTE	Data Terminal Equipment (typically computer, external controller)
DTR	Data Terminal Ready
DTX	Discontinuous Transmission
EFR	Enhanced Full Rate
EGSM	Extended GSM900 band (includes standard GSM900 band)
ESD	Electrostatic Discharge
FR	Full Rate
GLONASS	GLObalnaya NAvigatsionnaya Sputnikovaya Sistema, the Russian Global Navigation Satellite System
GMSK	Gaussian Minimum Shift Keying
GNSS	Global Navigation Satellite System
GPS	Global Positioning System
GSM	Global System for Mobile Communications
HR	Half Rate
HSPA	High Speed Packet Acess
I/O	Input/Output
IMEI	International Mobile Equipment Identity
Imax	Maximum Load Current
Inorm	Normal Current
LED	Light Emitting Diode
LNA	Low Noise Amplifier
MO	Mobile Originated
MS	Mobile Station (GSM engine)
MT	Mobile Terminated
PAP	Password Authentication Protocol



PBCCH	Packet Switched Broadcast Control Channel
PCB	Printed Circuit Board
PDU	Protocol Data Unit
PPP	Point-to-Point Protocol
PSK	Phase Shift Keying
QAM	Quadrature Amplitude Modulation
QPSK	Quadrature Phase Shift Keying
RF	Radio Frequency
RHCP	Right Hand Circularly Polarized
RMS	Root Mean Square (value)
RTC	Real Time Clock
Rx	Receive
SIM	Subscriber Identification Module
SMS	Short Message Service
TDMA	Time Division Multiple Access
TE	Terminal Equipment
TX	Transmitting Direction
UART	Universal Asynchronous Receiver & Transmitter
UMTS	Universal Mobile Telecommunications System
URC	Unsolicited Result Code
USIM	Universal Subscriber Identity Module
USSD	Unstructured Supplementary Service Data
Vmax	Maximum Voltage Value
Vnorm	Normal Voltage Value
Vmin	Minimum Voltage Value



V _{IH} max	Maximum Input High Level Voltage Value
V _{IH} min	Minimum Input High Level Voltage Value
V _{IL} max	Maximum Input Low Level Voltage Value
V _{IL} min	Minimum Input Low Level Voltage Value
V _I max	Absolute Maximum Input Voltage Value
V _I min	Absolute Minimum Input Voltage Value
V _{OH} max	Maximum Output High Level Voltage Value
V _{OH} min	Minimum Output High Level Voltage Value
V _{OL} max	Maximum Output Low Level Voltage Value
V _{OL} min	Minimum Output Low Level Voltage Value
VSWR	Voltage Standing Wave Ratio
WCDMA	Wideband Code Division Multiple Access



10 Appendix B GPRS Coding Scheme

Table 39: Description of Different Coding Schemes

Scheme	CS-1, CS-2, CS-3, C4-4
Code Rate	1/2, 2/3, 3/4, 1
USF	3, 3, 3, 3,
Pre-coded USF	3, 6, 6, 12
Radio Block excl.USF and BCS	181, 268, 312, 428
BCS	40, 16, 16, 16
Tail	4, 4, 4, -
Coded Bits	456, 588, 676,456
Punctured Bits	0, 132, 220, -
Data Rate Kb/s	9.05, 13.4, 15.6, 21.4



11 Appendix C GPRS Multi-slot Class

Twenty-nine classes of GPRS multi-slot modes are defined for MS in GPRS specification. Multi-slot classes are product dependant, and determine the maximum achievable data rates in both the uplink and downlink directions. Written as 3+1 or 2+2, the first number indicates the amount of downlink timeslots, while the second number indicates the amount of uplink timeslots. The active slots determine the total number of slots the GPRS device can use simultaneously for both uplink and downlink communications. The description of different multi-slot classes is shown in the following table.

Table 40: GPRS multi-slot classes

Multislot Class	Downlink Slots	Uplink Slots	Active Slots	
1	1	1	2	
2	2	1	3	
3	2	2	3	
4	3	1	4	
5	2	2	4	
6	3	2	4	
7	3	3	4	
8	4	1	5	
9	3	2	5	
10	4	2	5	
11	4	3	5	
12	4	4	5	



12 Appendix D EDGE Modulation and Coding Scheme

Table 41: EDGE Modulation and Coding Scheme

Coding scheme	Modulation	Coding family	1 Timeslot	2 Timeslot	4 Timeslot
CS-1:	GMSK	1	9.05kbps	18.1kbps	36.2kbps
CS-2:	GMSK	1	13.4kbps	26.8kbps	53.6kbps
CS-3:	GMSK	1	15.6kbps	31.2kbps	62.4kbps
CS-4:	GMSK	1	21.4kbps	42.8kbps	85.6kbps
MCS-1	GMSK	С	8.80 kbps	17.60 kbps	35.20 kbps
MCS-2	GMSK	В	11.2 kbps	22.4 kbps	44.8 kbps
MCS-3	GMSK	Α	14.8 kbps	29.6 kbps	59.2 kbps
MCS-4	GMSK	С	17.6 kbps	35.2 kbps	70.4 kbps
MCS-5	8-PSK	В	22.4 kbps	44.8 kbps	89.6 kbps
MCS-6	8-PSK	A	29.6 kbps	59.2 kbps	118.4 kbps
MCS-7	8-PSK	В	44.8 kbps	89.6 kbps	179.2 kbps
MCS-8	8-PSK	A	54.4 kbps	108.8 kbps	217.6 kbps
MCS-9	8-PSK	A	59.2 kbps	118.4 kbps	236.8 kbps